

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MASAMICHI ISHIHARA	04/16/2014
KENSHU OYAMA	04/16/2014
SHOJI MURAKAMI	04/21/2014
HITONOBU ONOSAKA	04/18/2014

RECEIVING PARTY DATA

Name:	STEQ INC.
Street Address:	1-8, HIBIKINO, WAKAMATSU-KU
City:	KITAKYUSHU-SHI, FUKUOKA
State/Country:	JAPAN
Postal Code:	808-0135
Name:	SSTECHNO, INC.
Street Address:	433-6, TERAUFUKUDO
City:	OGORI-SHI, FUKUOKA
State/Country:	JAPAN
Postal Code:	838-0138
Name:	SHIKOKU INSTRUMENTATION CO., LTD.
Street Address:	200-1, MINAMIGAMO, TADOTSU-CHO
City:	NAKATADO-GUN, KAGAWA
State/Country:	JAPAN
Postal Code:	764-8502

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14236584

CORRESPONDENCE DATA**Fax Number:** (202)822-1111**Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.****Phone:** 202-822-1100**Email:** patentmail@whda.com**Correspondent Name:** WESTERMAN HATTORI DANIELS & ADRIAN, LLP**PATENT**

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ATTORNEY DOCKET NUMBER:	131573
NAME OF SUBMITTER:	SADAO KINASHI
SIGNATURE:	/Sadao Kinashi/
DATE SIGNED:	04/23/2014

Total Attachments: 3

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Docket No.:

WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the adequacy and receipt of which is hereby acknowledged by the undersigned inventor(s) (hereinafter ASSIGNOR) by

(Insert ASSIGNEE'S Name(s) Address(es))

STEQ INC. 1-8, Hibikino, Wakamatsu-ku, Kitakyushu-shi, Fukuoka 8080135 JAPAN
SSTechno, Inc. 433-6, Terafukudo, Ogori-shi, Fukuoka 8380138 JAPAN
Shikoku Instrumentation CO., LTD. 200-1, Minamigamo, Tadotsu-cho, Nakatado-gun, Kagawa 7648502 JAPAN

(hereinafter ASSIGNEE), the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

SEMICONDUCTOR DEVICE AND FABRICATION METHOD FOR SAME

(Title of Invention)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

filed on January 31, 2014 Application No. 14/236,584

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application (e.g., provisional or non-provisional) or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

The ASSIGNOR sells, assigns and transfers to said ASSIGNEE the entire and exclusive right, title and interest to the application and the invention(s) disclosed therein for the United States of America and all countries foreign to the United States and do hereby authorize said ASSIGNEE to apply for patents therefore in its own name in countries where such procedure is proper and to claim the priority right under the International Convention and agrees to execute all papers necessary in connection with applications for such patents and any continuation, divisional, substitute, reissue or reexamination applications thereof and also execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

<u>Masamichi Ishihara</u> (Signature)	<u>Masamichi ISHIHARA</u> (Type Name)	<u>4/16/2014</u> (Date)
_____ (Signature)	<u>Kenshu OYAMA</u> (Type Name)	_____ (Date)
_____ (Signature)	<u>Shoji MURAKAMI</u> (Type Name)	_____ (Date)
_____ (Signature)	<u>Hitonobu ONOSAKA</u> (Type Name)	_____ (Date)

NO LEGALIZATION REQUIRED

PATENT

REEL: 032740 FRAME: 0290

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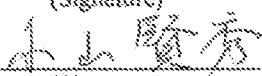
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(Signatures)

_____	Masamichi ISHIHARA	_____
(Signature)	(Type Name)	(Date)
		
_____	Kenshu OYAMA	<u>April 16, 2014</u>
(Signature)	(Type Name)	(Date)
_____	Shoji MURAKAMI	_____
(Signature)	(Type Name)	(Date)
_____	Hironobu ONOSAKA	_____
(Signature)	(Type Name)	(Date)

NO LEGALIZATION REQUIRED

Docket No.:

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(Signature)	(Type Name)	(Date)
_____	Kenshu OYAMA	_____
(Signature)	(Type Name)	(Date)
<u>村上 昭二</u>	Shoji MURAKAMI	<u>2014.04.21</u>
(Signature)	(Type Name)	(Date)
<u>小野坂 仁伸</u>	Hitonobu ONOSAKA	<u>2014.04.18</u>
(Signature)	(Type Name)	(Date)

NO LEGALIZATION REQUIRED

PATENT

RECORDED: 04/23/2014

REEL: 032740 FRAME: 0292